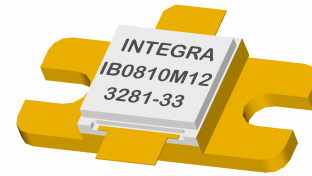


# Part Number: IB0810M12

**Integra**  
TECHNOLOGIES, INC.

## L-Band Radar Transistor

The high power pulsed radar transistor device part number IB0810M12 is designed for L-Band radar systems operating over the instantaneous bandwidth of 870-990 MHz. While operating in class C mode this common base device supplies a minimum of 12 watts of peak pulse power under the conditions of 300µs pulse width and 15% duty cycle. All devices are 100% screened for large signal RF parameters in a broadband RF test fixture with no external tuning. Excellent spectral stability into output mismatch over a broad input power range make it ideal for use in reliable high power solid state transmitters.



- Silicon Bipolar
  - Ultra-high  $f_T$
- Class C Operation
  - High Efficiency
- Common Base Configuration
  - Single Power Supply
- Gold Metal
  - Maximum Reliability
- Emitter Ballasting
  - Optimum Thermal Distribution
- Internal Impedance Matching
  - Ease of Use
  - Ultra-low Loss Design
- BeO Package
  - Unmatched Thermal Reliability
- RF Test Fixture
  - Broadband
  - Matched to 50Ω
  - Long-term Correlation
  - 100% Device RF Screening
  - No External Tuning Allowed

*TYPICAL DATA      TYPICAL DATA      TYPICAL DATA      TYPICAL DATA*

FREQ (MHz)	Pout (W)	1 dB-OD-Pout (W)	Pin (W)	Ic (A)	IRL (dB)	Droop (dB)	Gain (dB)	Nc (%)	Δ Gain (dB)	VSWR	
										2:1	3:1
870	12	13.7	2.1	0.627	19	-0.12	7.5	53	0.77	S	P
930	12	14.2	2.0	0.620	18	-0.12	7.7	54		S	P
990	12	13.6	1.8	0.620	17	-0.13	8.3	54		S	P

**MAXIMUM RATINGS**

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
BD	Collector-Emitter Voltage	$V_{CES}$	--	75	V	$V_{BE}=0V$ .
BD	Emitter-Base Voltage	$V_{EBO}$	--	3.0	V	--
BD	Storage Temperature Range	$T_{STG}$	-65	+200	°C	--
BD	Operating Junction Temperature Range	$T_J$	-55	+200	°C	--
Note	Screen 'BD' = parameter qualified By Design.					

**THERMAL CHARACTERISTICS**

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
BD	Thermal Resistance	$R_{TH(JC)}$	--	3.25	°C/W	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=12W$ .
Note	Screen 'BD' = parameter qualified By Design.					

**PROCESSING SPECIFICATIONS**

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	DC Wafer Probe	--	--	--	--	Per Integra specification.
Q1	Wafer DC and RF Qualification	--	--	--	--	Per Integra specification.
LM	Wire Bond Strength	--	--	--	--	Line monitor per Integra specification.
100%	Pre-cap visual inspection	--	--	--	--	Per Integra specification.
100%	Gross leak test	--	--	--	--	MIL-STD-750D, Method 1071, Test Condition C.
BD	Fine leak test	--	--	--	--	MIL-STD-750D, Method 1071, Test Condition H.
Note	Screen 'Q1' = parameter is qualified by assembly and test of 3 pieces minimum per wafer.					
Note	Screen 'LM' = parameter is qualified by assembly line monitor.					
Note	Screen 'BD' = parameter qualified By Design.					

**DC ELECTRICAL CHARACTERISTICS**

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	Collector-Emitter Breakdown Voltage	$BV_{CES}$	75	--	V	$I_C=5mA, V_{BE}=0V, T_F=25\pm5^\circ C$ .
100%	Zero Base Voltage Collector Leakage Current	$I_{CES}$	--	1	mA	$V_{CE}=30V, V_{BE}=0V, T_F=25\pm5^\circ C$ .
100%	DC Current Gain	$H_{FE}$	10	100	--	$V_{CE}=5V, I_C=0.1A, T_F=25\pm5^\circ C$ .

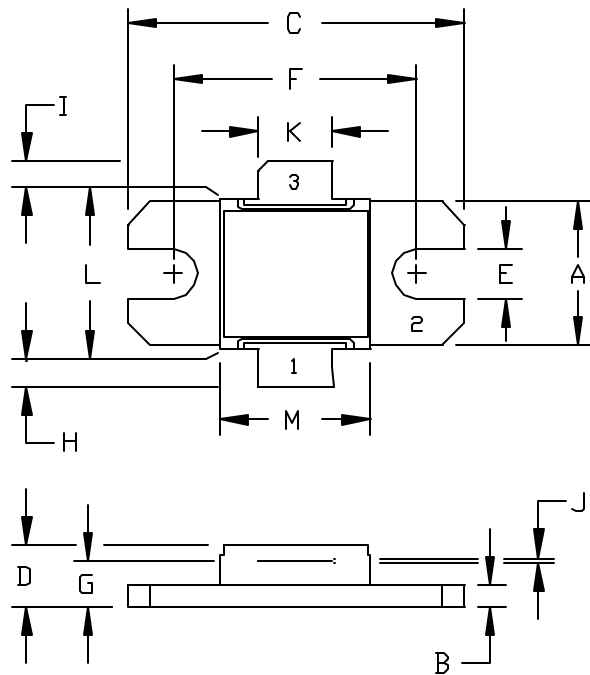
**RF ELECTRICAL CHARACTERISTICS**

Screen	Parameter	Symbol	Min	Max	Units	Test Conditions
100%	Input Return Loss	IRL	10	--	dB	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$
100%	Input Power	$P_{IN}$	1.5	2.4	W	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$
100%	Collector Efficiency ( $P_o/I_c/V_{CC}$ )	$N_c$	45	--	%	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$
100%	Power Gain	G	7.0	9.0	dB	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$
100%	Pulse Amplitude Droop	D	--	0.5	dB	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$ Delta peak power between 10 and 290us time positions.
100%	Power Gain Flatness versus Frequency	PGF	--	1.0	dB	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$ Calculate from $G_{MAX} - G_{MIN}$ @ $F=F1, F2$ & $F3.$
100%	Stability into 2:1 VSWR	VSWR-S	--	--	--	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$ Repeat $P_o.$ Rotate 2:1 output VSWR through $360^\circ$ phase. No oscillatory or pulse break-up characteristics allowed on detected output pulse. All non-harmonically related signals must be at least $-65$ dBc.
100%	3:1 Load Mismatch Tolerance	LMT	--	--	--	$V_{CC}=V1, PW=PW1, DF=DF1, T_F=25\pm5^\circ C, P_{OUT}=P_{OUT1}, F=F1, F2, F3.$ Repeat $P_o.$ Rotate 3:1 output VSWR through $360^\circ$ phase. Post-test $P_o =$ Pre-test $P_o \pm 2.5W.$
Note	$V1 = 36V; PW1 = 300\mu s; DF1 = 15%; P_{OUT1} = 12W; F1 = 870$ MHz, $F2 = 930$ MHz, $F3 = 990$ MHz.					
Note	$T_F =$ Device flange temperature.					

**BROADBAND RF TEST FIXTURE IMPEDANCE CHARACTERISTICS**

Frequency (MHz)	$Z_{IF}$ (W)	$Z_{OF}$ (W)
870	$3.8 - j4.8$	$8.4 + j11.2$
930	$3.8 - j4.5$	$8.9 + j10.3$
990	$3.7 - j4.5$	$8.5 + j13.4$
Impedance Definition		

PACKAGE DIMENSIONAL OUTLINE DRAWING



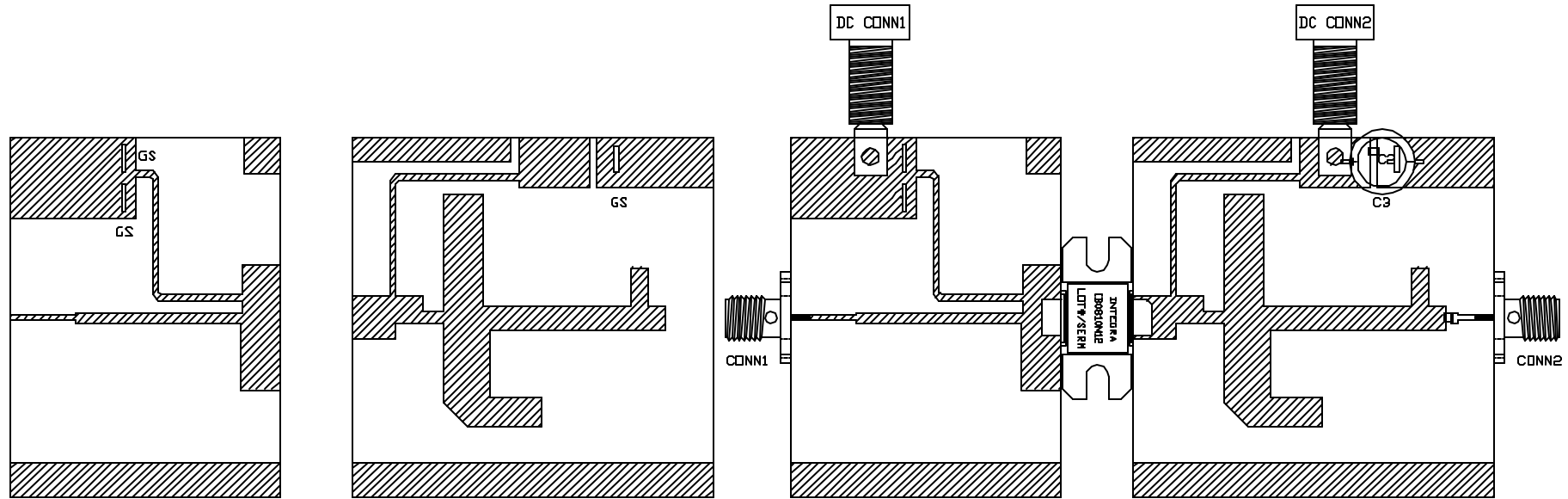
DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.380	0.390	9.65	9.91
B	0.058	0.062	1.47	1.57
C	0.895	0.905	22.73	22.99
D	0.157	0.177	3.99	4.50
E	0.125	0.135	3.18	3.43
F	0.645	0.655	16.38	16.64
G	0.112	0.132	2.84	3.35
H	0.090	0.255	2.29	6.48
I	0.090	0.255	2.29	6.48
J	0.003	0.005	0.08	0.13
K	0.195	0.205	4.95	5.21
L	0.395	0.405	10.03	10.29
M	0.395	0.405	10.03	10.29

PIN SCHEDULE	
1	EMITTER
2	BASE
3	COLLECTOR

DOCUMENT NUMBER: IB0810M12	REV: NC
SHEET NAME: 06-OUTLINE	REV: NC

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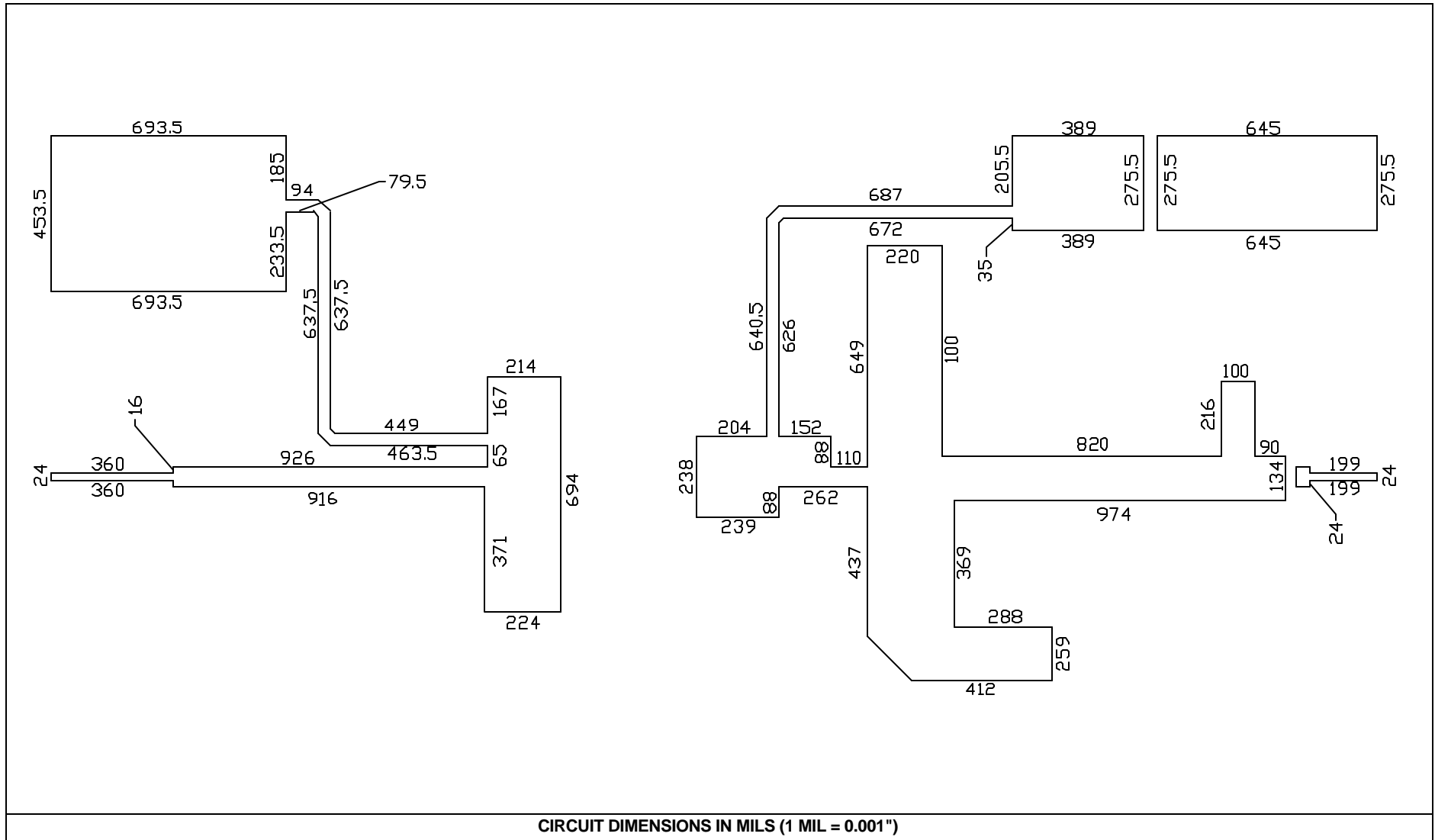
**BROADBAND RF TEST FIXTURE**



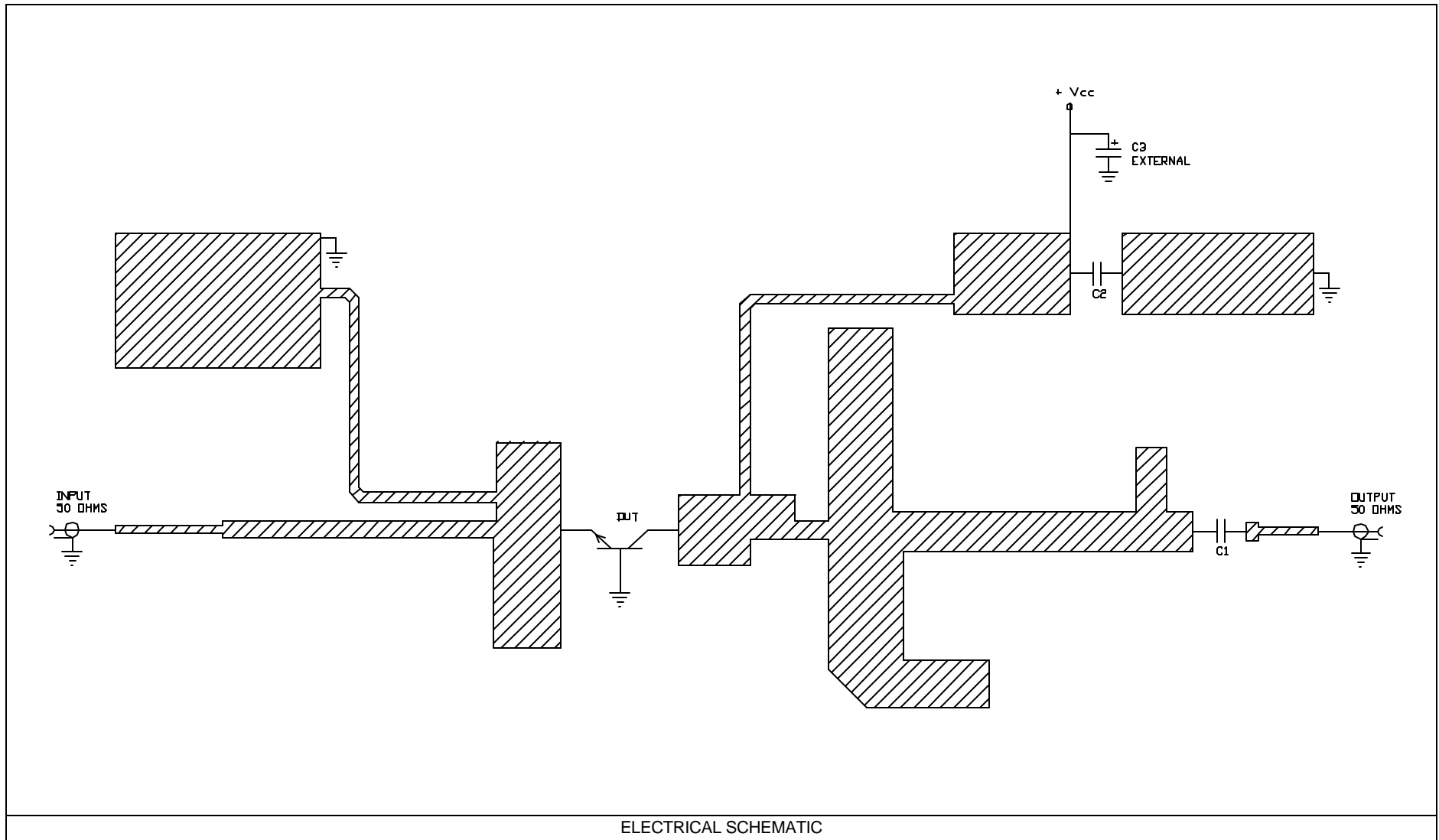
COMPONENT	DESCRIPTION
JUT	TRANSISTOR #IB0810M12, MOUNT HARD TO THE RIGHT
PC BOARD	ROGERS #R03010, TH=0.025"
C1, C2	CHIP CAPACITOR, TYPE ATC100A, 100 pF
C3	ELECTROLYTIC CAPACITOR, 68uF / 63V
GS	GROUND SHIELD, COPPER, TH=0.001"
CONN1, CONN2	SMA CONNECTOR, TYPE DS #2052-5636-02
INPUT PC BOARD CARRIER	2 INCH BRASS - 05 (1.5")
OUTPUT PC BOARD CARRIER	2 INCH BRASS - 06 (2.0")
TRANSISTOR CARRIER	2 INCH COPPER - 02
TRANSISTOR CLAMP	NORYL CLAMP - 03
HEATSINK	2 INCH HEATSINK - 11
DC CONN1	BANANA JACK, BLACK
DC CONN2	BANANA JACK, RED
NOTE	FIXTURE HARDWARE DRAWINGS AVAILABLE ON REQUEST

**ASSEMBLY AND PARTS LIST**

**BROADBAND RF TEST FIXTURE**



**BROADBAND RF TEST FIXTURE**



**DEFINITIONS**

<b>Data Sheet Status</b>	
Proposed Specification	This data sheet contains proposed specifications.
Preliminary Specification	This data sheet contains specifications based on preliminary measurements and data.
Product Specification	This data sheet contains final product specifications.
<b>Maximum Ratings</b>	
Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only and operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability.	

**WARNING**

<b>Product and environmental safety - toxic materials</b>
This product contains beryllium oxide. The product is entirely safe provided that the BeO base is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with general or domestic waste.

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